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U.S.S.N. 10,811,621

Claim Amendments

Please amend claims 1 and 9 as follows:

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Listing of Claims

1. (currently amended) An electrolyte bath, comprising:

a metal electroplating electrolyte solution, said electrolyte solution contained in an electrolyte bath container; and

a composition comprising an organic acid and a non-ionic polymer mixed with said organic acid, said non-ionic polymer selected from the group consisting of an alkoxyated alcohol, an alkoxyated amine, and an alkylphenol alkoxyate;

wherein said composition is disposed as a suspended layer within said electrolyte solution, said suspended layer spanning said electrolyte bath container, said suspended layer of sufficient dimension to form a wetting layer on a substrate as said substrate is passed through said suspended layer into said electrolyte solution, said electrolyte bath further comprising an anode to carry out ~~an electroplating process~~ said metal electroplating in said electrolyte solution on said substrate comprising said wetting layer.

2. (previously presented) The electrolyte bath of claim 1 wherein said organic acid is selected from the group consisting of citric

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acid and acetic acid.

3. (canceled)

4. (previously presented) The electrolyte bath of claim 1 wherein said composition is present in said electrolyte solution in a concentration of about 5 % by weight.

5. (previously presented) The electrolyte bath of claim 1 wherein said non-ionic polymer has a molecular weight of less than 1,000.

6. (previously presented) The electrolyte bath of claim 5 wherein said organic acid is selected from the group consisting of citric acid and acetic acid.

7. (previously presented) The electrolyte bath of claim 1 wherein said organic acid is present in said composition in a wt.% of about 10, and wherein said non-ionic polymer is present in said composition in a wt.% of about 5.

8. (canceled)

9. (currently amended) An electrolyte bath, comprising:

a copper electroplating electrolyte solution, said

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electrolyte solution contained in an electrolyte bath container;
and

a composition comprising an organic acid and a non-ionic polymer, said non-ionic polymer having a molecular weight of less than 1,000, said non-ionic polymer mixed with said organic acid, said non-ionic polymer selected from the group consisting of an alkoxyated alcohol, alkoxyated amine, and an alkylphenol alkoxyate, said organic acid selected from the group consisting of citric acid and acetic acid;

wherein said composition is disposed as a suspended layer within said electrolyte solution, said suspended layer spanning said electrolyte bath container, said suspended layer of sufficient dimension to form a wetting layer on a substrate as said substrate is passed through said suspended layer into said electrolyte solution, said electrolyte bath further comprising an anode to carry out ~~an electroplating process~~ said copper electroplating in said electrolyte solution on said substrate comprising said wetting layer.

10. (canceled)

11. (canceled)

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12. (previously presented) The electrolyte bath of claim 9 wherein said composition is present in said electrolyte solution in a concentration of about 5% by weight.

13. (previously presented) The electrolyte bath of claim 9 wherein said organic acid is present in said composition in a wt.% of about 10, and wherein said non-ionic polymer is present in said composition in a wt.% of about 5.

Claims 14-16 (canceled)

Claims 17-20 (canceled)

21. (previously presented) The electrolyte bath of claim 1, wherein said non-ionic polymer is present in said composition in a quantity of from about 0.5 to about 10 wt. %.

22. (previously presented) The electrolyte bath of claim 1, wherein said organic acid is present in said composition in a quantity of from about 2 to about 20 wt. %.

23. (previously presented) The electrolyte bath of claim 9, wherein said non-ionic polymer is present in said composition in a quantity of from about 0.5 to about 10 wt. %.

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24. (previously presented) The electrolyte bath of claim 9, wherein said organic acid is present in said composition in a quantity of from about 2 to about 20 wt. %.

25. (canceled)

26. (canceled)